



## **SPECIFICATION** (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL32A107MPVNNNE
- Description : CAP, 100 µF
  - : CAP, 100μF, ±20%, 10V, X5R, 1210

A. Samsung Part Number

		<u>CL</u> ①	<u>32</u> ②	<u>A</u> <u>107</u> 3 4	<u>M</u> 5	<u>P</u> 6	⊻ ⑦	<u>N</u> 8	<u>N</u> 9	<u>N</u> 10	<u>Е</u> 11	
1	Series	Samsung Multi-layer Ceramic Capacitor										
2	Size	1210 (inch c	ode)	L:	3.2	± 0.4		mm		W:	$2.5 \pm 0.3$	mm
3	Dielectric	X5R			8	Inne	r ele	ctrode	•	I	Ni	
4	Capacitance	<b>100</b> µF				Tern	ninat	ion		(	Cu	
5	Capacitance	±20 %				Plati	ng			ŝ	Sn 100%	(Pb Free)
	tolerance				9	Prod	luct			1	Normal	
6	Rated Voltage	10 V			10	Spec	cial			F	Reserved for	future use
1	Thickness	$2.5 \pm 0.3$	mm		1	Pack	cagin	g		E	Embossed T	ype, 7" reel

## B. Samsung Reliablility Test and Judgement condition

	Performance	Test condition					
Capacitance	Within specified tolerance	120Hz ±20% 0.5±0.1Vrms *A capacitor prior to measuring the capacitance is heat treated at $150^{\circ}$ +0/-10°C, and maintained in ambient air for 24±2 hours.					
Tan δ (DF)	0.1 max.						
Insulation	10,000Mohm or 100Mohm · <i>µ</i> F	Rated Voltage 60~120 sec.					
Resistance	Whichever is Smaller						
Appearance	No abnormal exterior appearance	Microscope (×10)					
Withstanding	No dielectric breakdown or	250% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	X5R						
Characterisitcs	(From -55 $^{\circ}$ C to 85 $^{\circ}$ C, Capacitance change shoud be within ±15%)						
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)					
		with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder					
	is to be soldered newly	245±5℃, 3±0.3sec.					
		(preheating : 80~120 ℃ for 10~30sec.)					
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.					
Soldering heat	Tan δ, IR : initial spec.						

	Performance	Test condition					
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm					
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)					
		2hours $\times$ 3 direction (x, y, z)					
Moisture	Capacitance change : within ±12.5%	With rated voltage					
Resistance	Tan δ: 0.125 max	40±2℃, 90~95%RH, 500+12/-0hrs					
	IR : 500Mohm or 12.5 Mohm · μF						
	Whichever is Smaller						
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage					
Resistance	Tan δ: 0.125 max	Max. operating temperature					
	IR : 1,000Mohm or 25Mohm · μF						
	Whichever is Smaller	1000+48/-0hrs					
Temperature	Capacitance change : within ±7.5%	1 cycle condition					
Cycling	Tan δ, IR : initial spec.	Min. operating temperature $\rightarrow$ 25 °C					
		$\rightarrow$ Max. operating temperature $\rightarrow$ 25 °C					
		5 cycle test					

## C. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max )

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.